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(12) **United States Design Patent** (10) **Patent No.:** **US D897,297 S**
Ishii et al. (45) **Date of Patent:** **** Sep. 29, 2020**

(54) **CONDUCTIVE STICKER**

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(**) Term: **15 Years**

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(51) **LOC (12) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**
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CPC ... H01B 1/24; H01B 1/06; H01B 1/04; H01B 1/02; H01B 1/023; H01B 1/14; H01B 1/16; H01B 1/18; H05K 1/0271; H05K 1/0274; H05K 1/00; H05K 1/02; H05K 1/11; H05K 1/0296; H05K 3/30; H05K 3/34; H05K 3/36; H05K 3/40; C08J 5/18; C08J 5/02; C08J 5/12; C08J 5/128; C08J 5/047; G06F

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(57) **CLAIM**

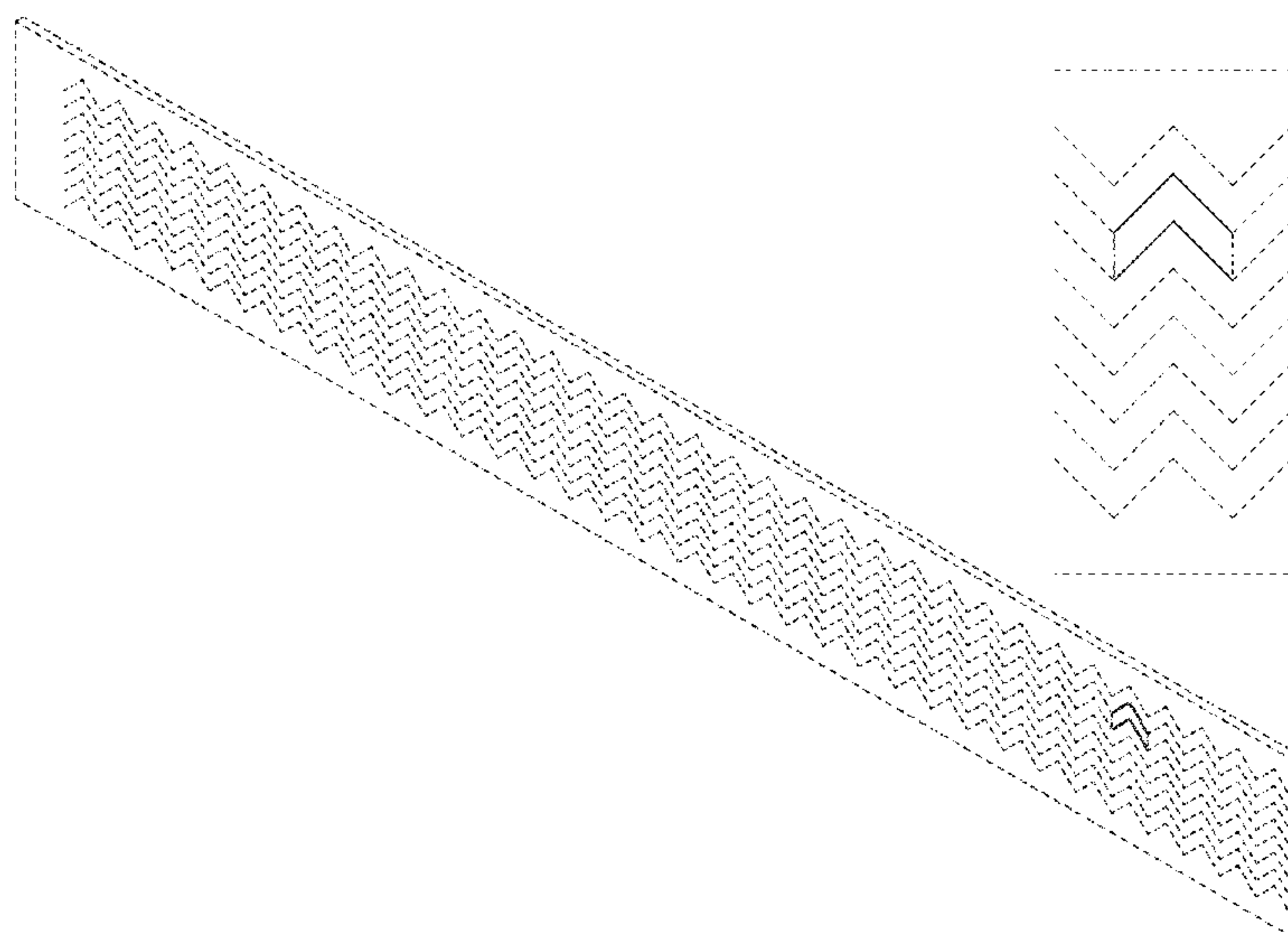
The ornamental design for a conductive sticker, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a conductive sticker, showing our new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a top view thereof;
FIG. 5 is a bottom view thereof;
FIG. 6 is a right view thereof;
FIG. 7 is a left view thereof;
FIG. 8 is an enlarged view of FIG. 6;
FIG. 9 is a cross sectional view taken along line 9-9 of FIG. 2;
FIG. 10 is an enlarged view of portion 10-10 of FIG. 2; and,
FIG. 11 is an enlarged view of portion 11-11 of FIG. 3.

The even dashed broken lines shown in the drawings represent portions of the conductive sticker that form no part of the claimed design. The dashed-dot lines adjacent the solid lines and the dash-dot lines showing the arrows represent boundary lines.

1 Claim, 3 Drawing Sheets



(58) **Field of Classification Search**
 CPC 3/041; G06F 3/044; G06F 3/047; H01L
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 B60R 16/06; B62D 37/00; H03K 17/975
 See application file for complete search history.

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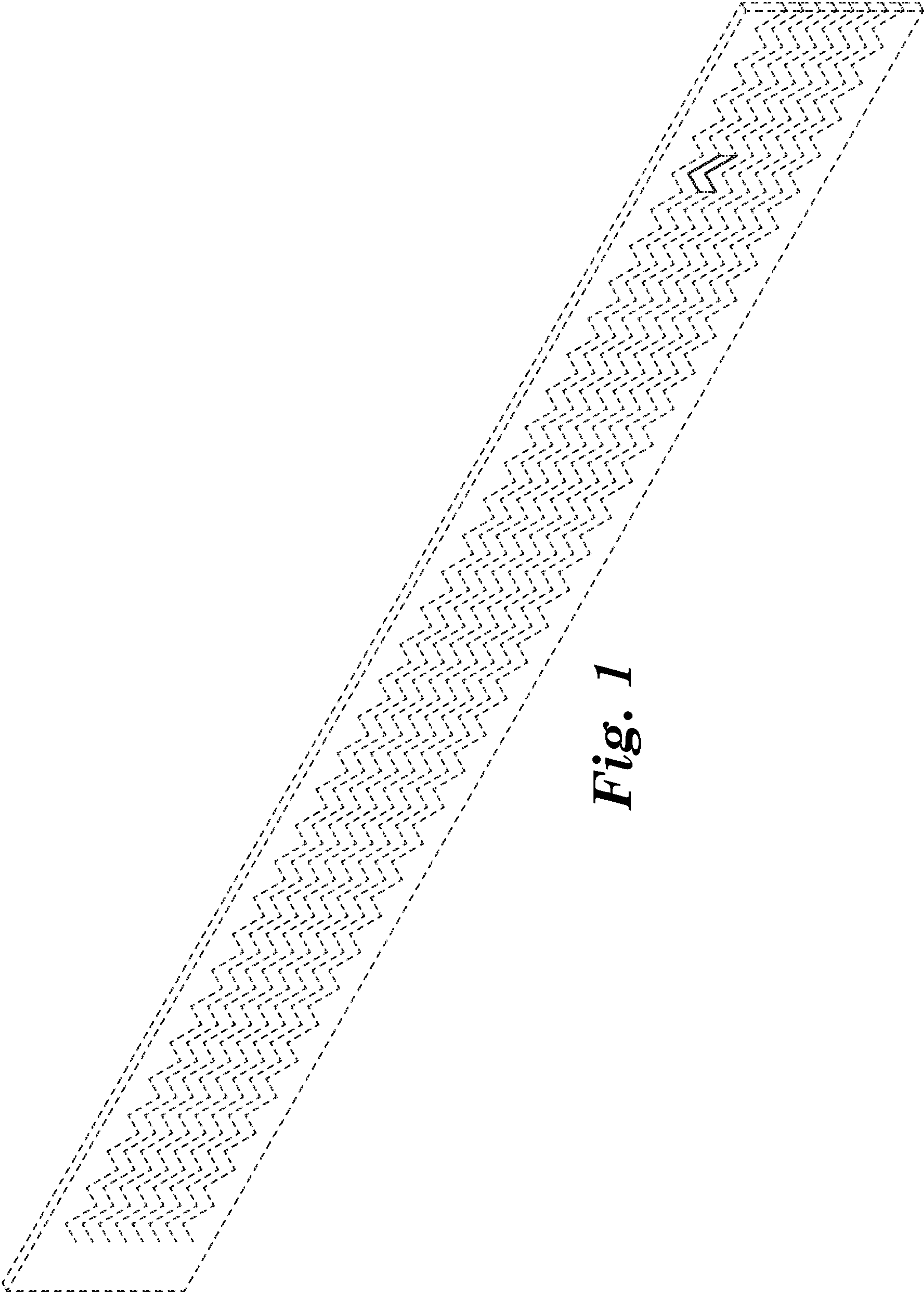


Fig. 1

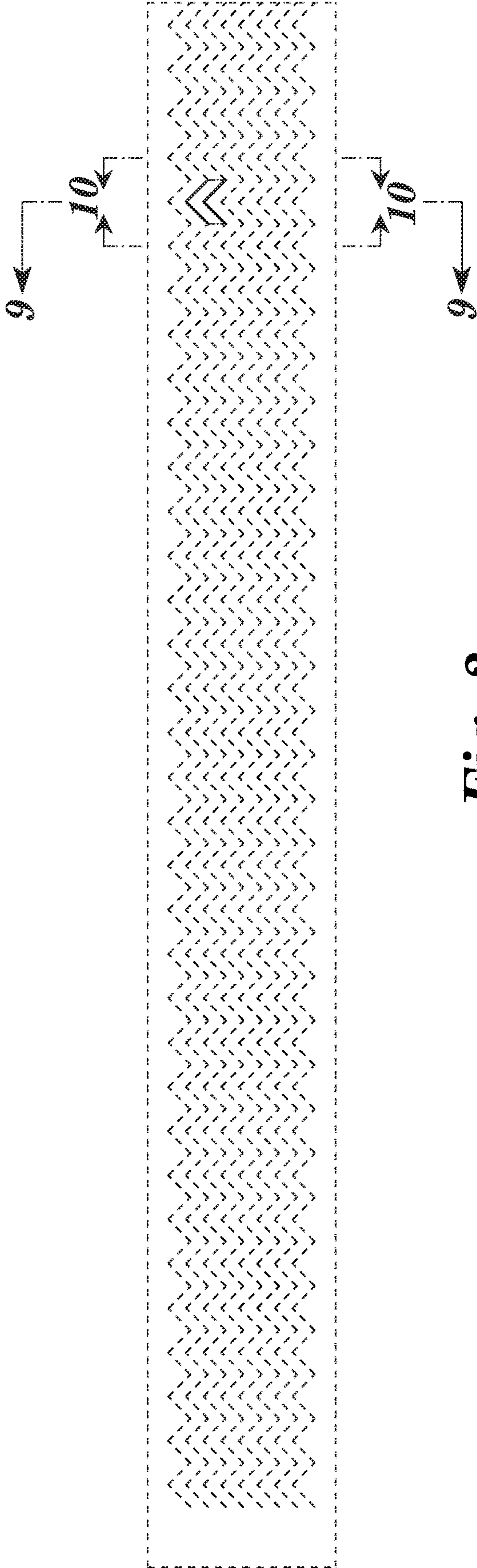


Fig. 2

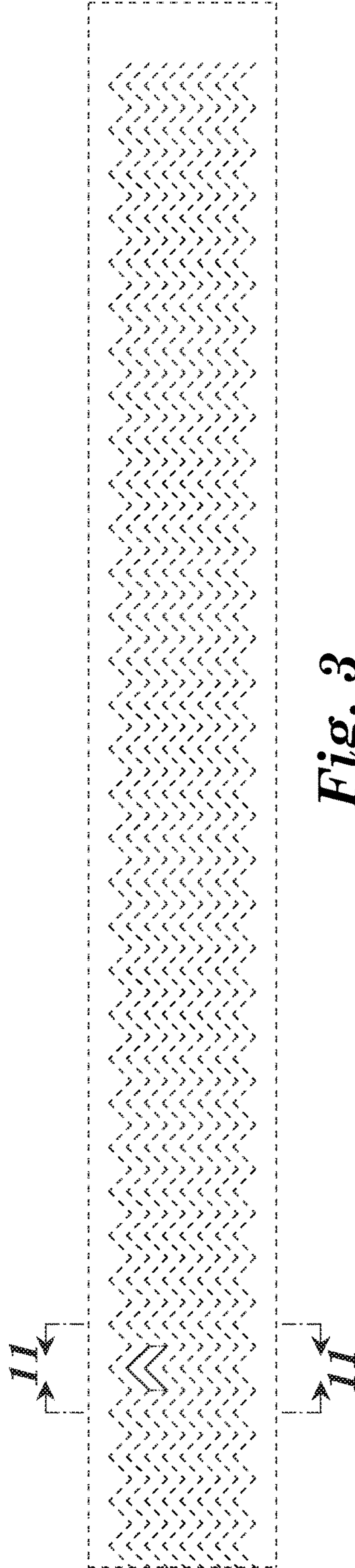


Fig. 3

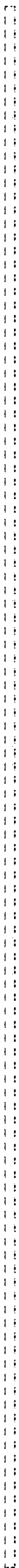


Fig. 4

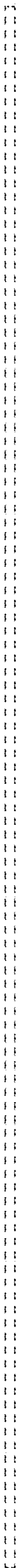


Fig. 5

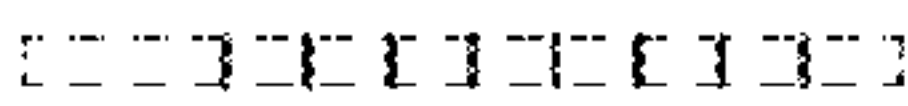


Fig. 6

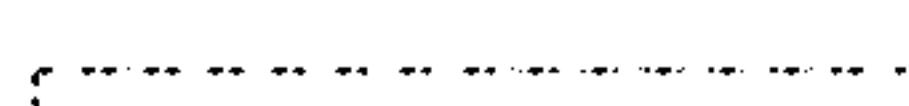


Fig. 7

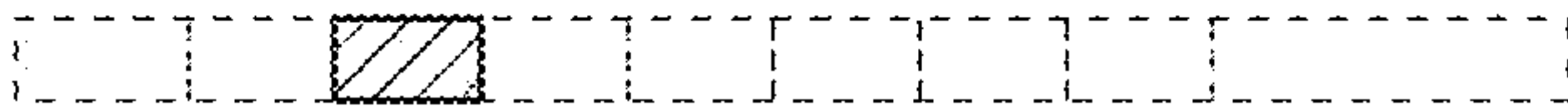


Fig. 8

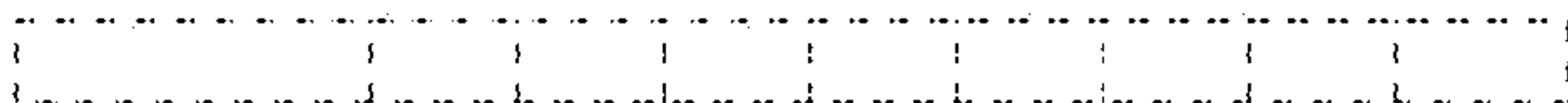


Fig. 9

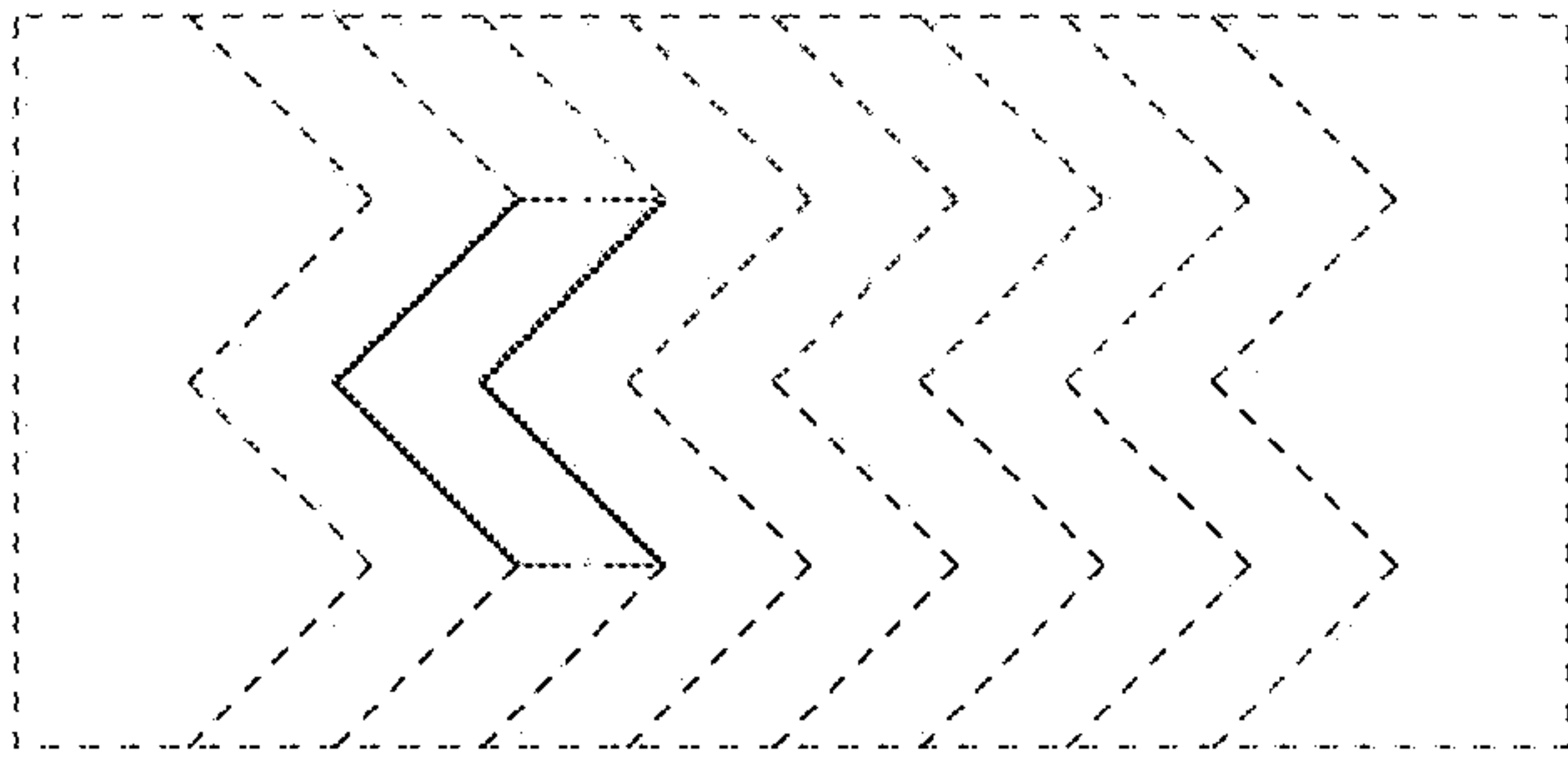


Fig. 10

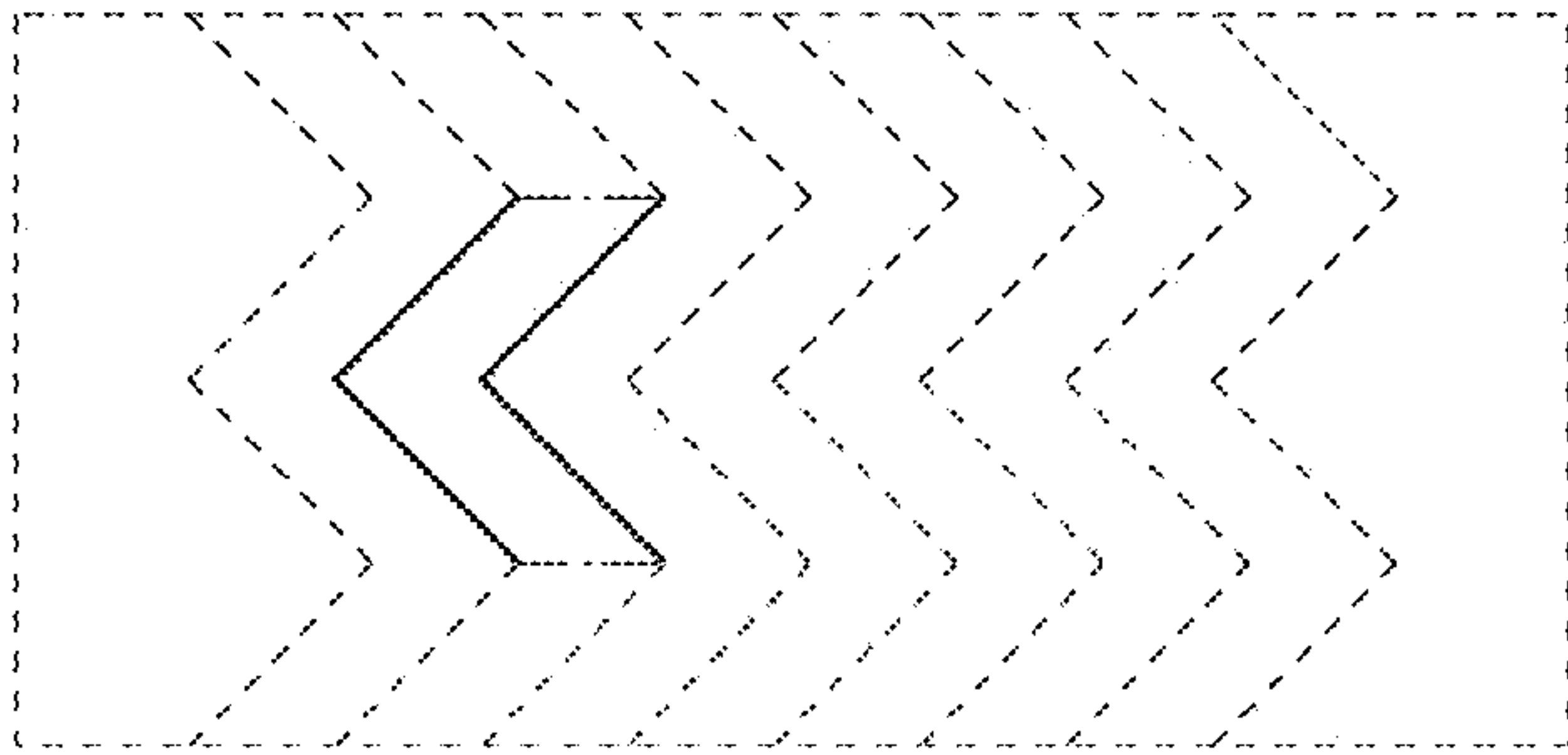


Fig. 11